

HiPIMS Today



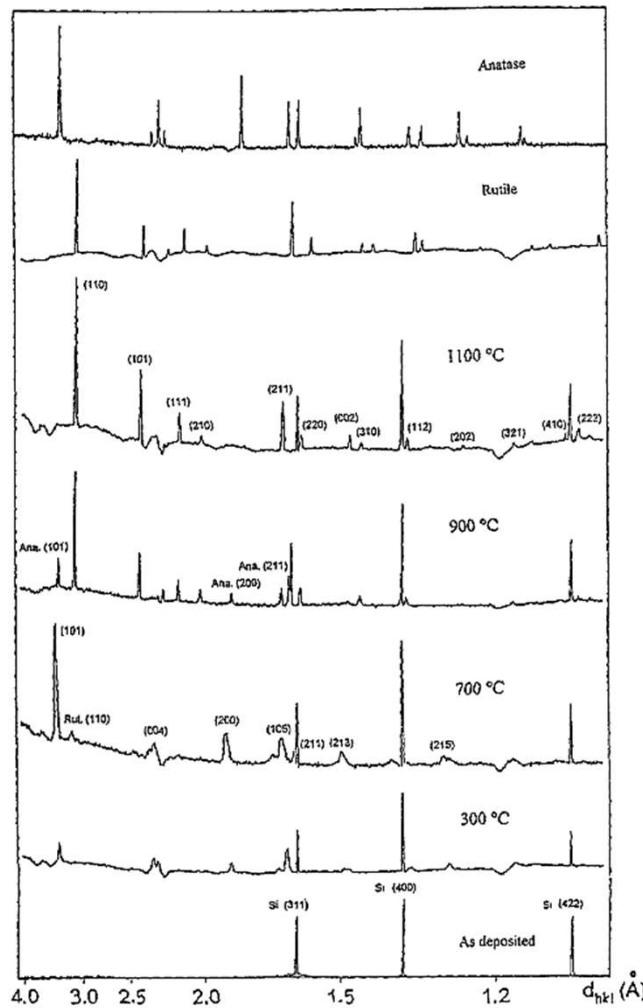
On the synthesis of Titanium Dioxide, from DCMS to Bipolar HiPIMS

stephanos.konstantinidis@umons.ac.be



In the last century...

Annealing DC MS TiO₂ films



Rutile @ high temperature
Anatase @ « medium » temperature

← Rutile (1100°C)

← Anatase + Rutile (900°C)

← Anatase (300°C)

← Amorphous (25°C)



YESTERDAY
Reactive HiPIMS of TiO₂ thin films

Growth of TiO₂ films, DCBPMS vs HiPIMS

HiPIMS discharge in Ar – O₂ (40% O₂) at 1 Pa (7mTorr)

Pulse characteristics :

- Duration : Short pulses of **7μs**
- Voltage : 900V → peak current : **200A**
- Repetition frequency : 1 – 3 kHz
- Average power : 1.5 – 2 kW
- 450 x 150 mm rectangular Ti target

DC Bipolar Pulsed Magnetron discharge (DCBPM):

- Frequency : 150 kHz
- Positive pulse duration : 2016 ns
- Same average power

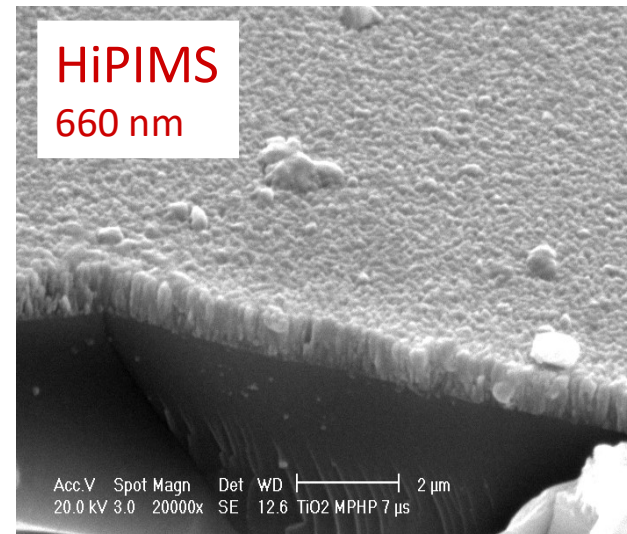
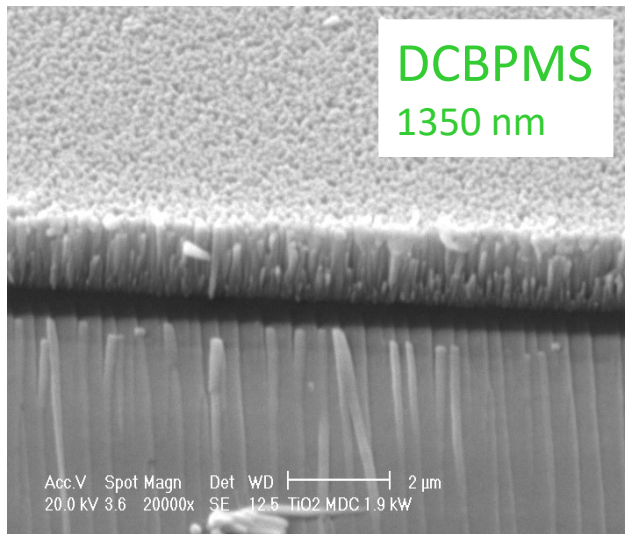
Substrates : - Glass (4 mm thick)
- Steel foils (0.2 mm thick).

Thickness and morphology

<i>Sputtering Technique</i>	<i>Film Thickness</i> <i>(mechanical profilometer - Films on glass)</i>
DC-BPM	1350 nm
HiPIMS	660 nm

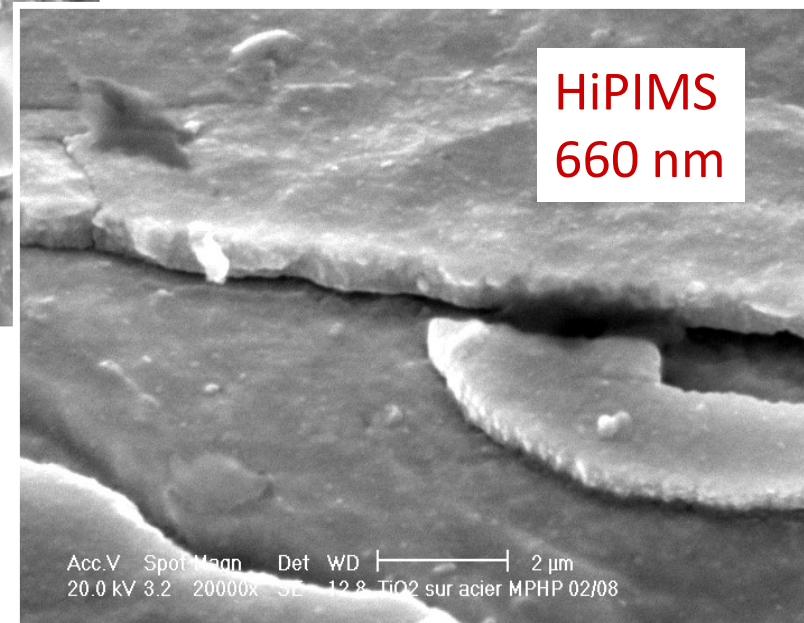
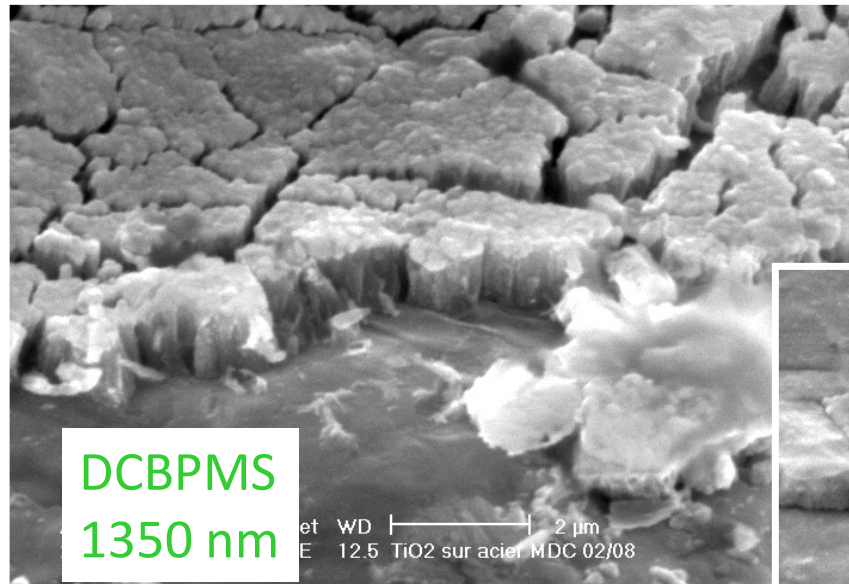
Films deposited (Power = 1.7 kW, 6 h duration)

Morphology, HiPIMS deposited TiO_2 films on glass

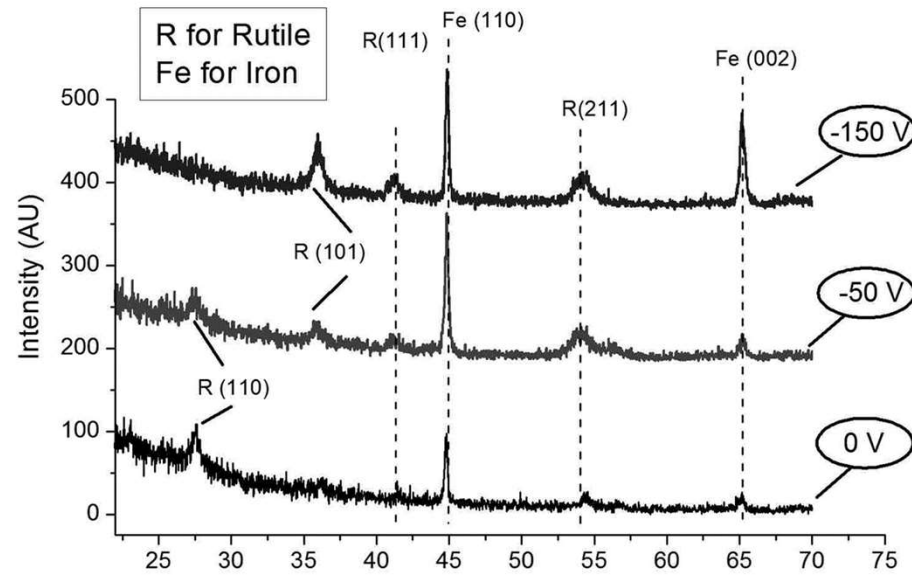


X-ray Fluorescence measurements have shown
HiPIMS films are **denser** than DCBPMS ones (~20%)

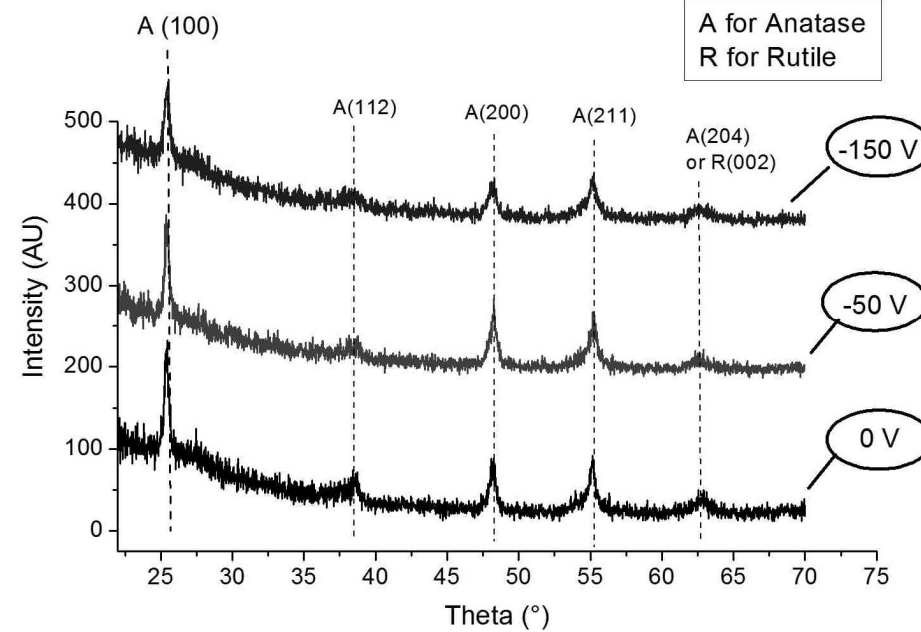
Morphology of TiO₂ films on steel substrates



Crystalline structure of HiPIMS TiO₂ coatings

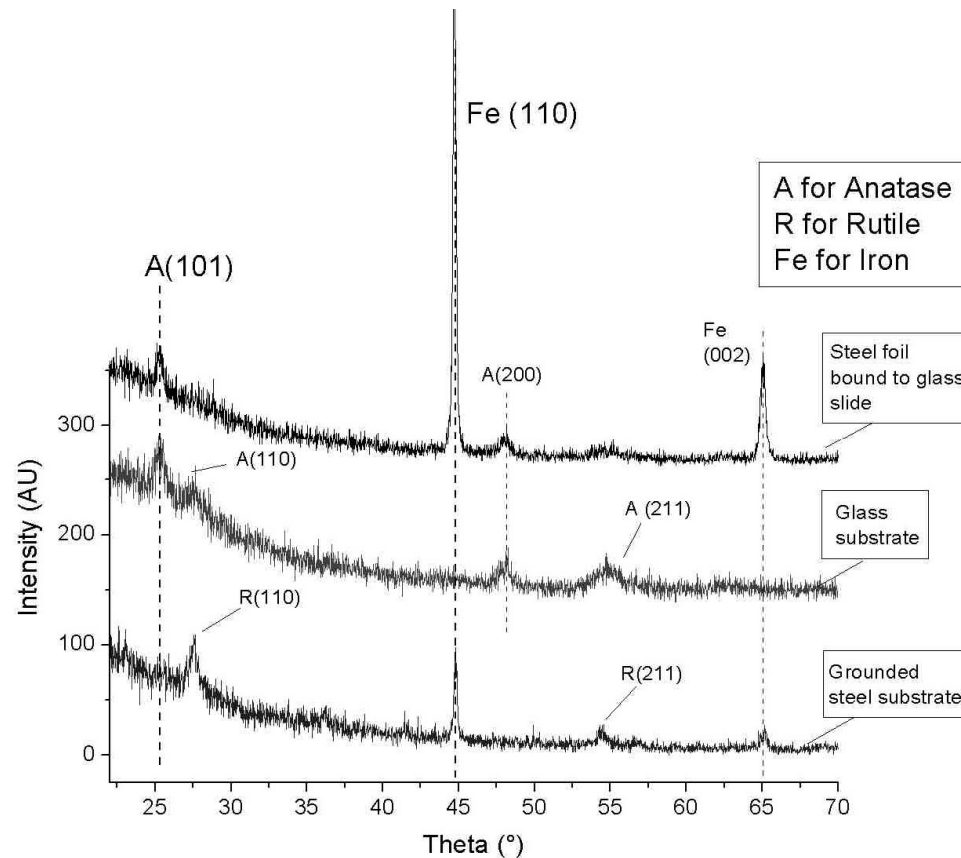


On **steel foil**
⇒ **RUTILE**, even
without substrate bias



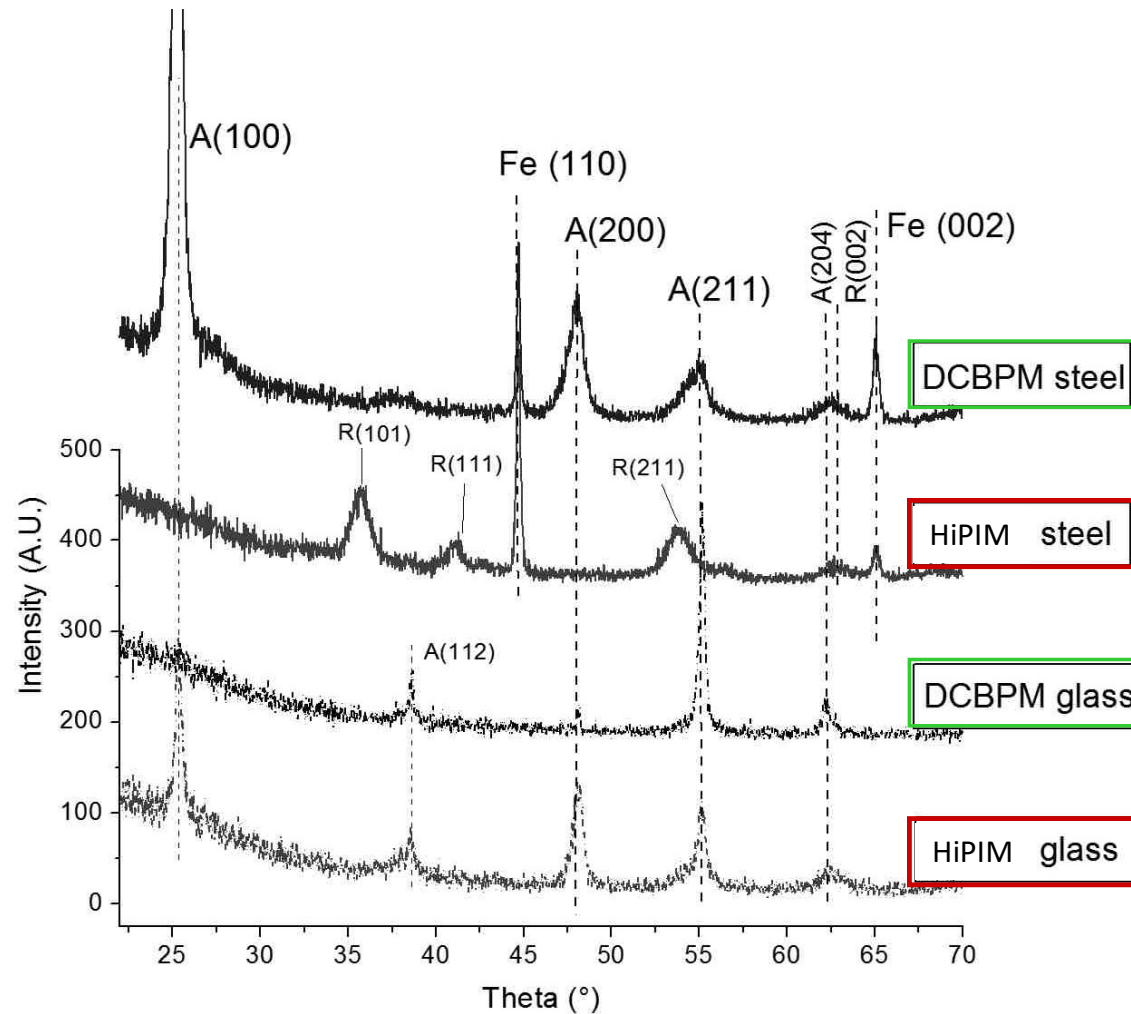
On **glass plate**
⇒ **ANATASE** structure

What if the steel substrate is floating ?



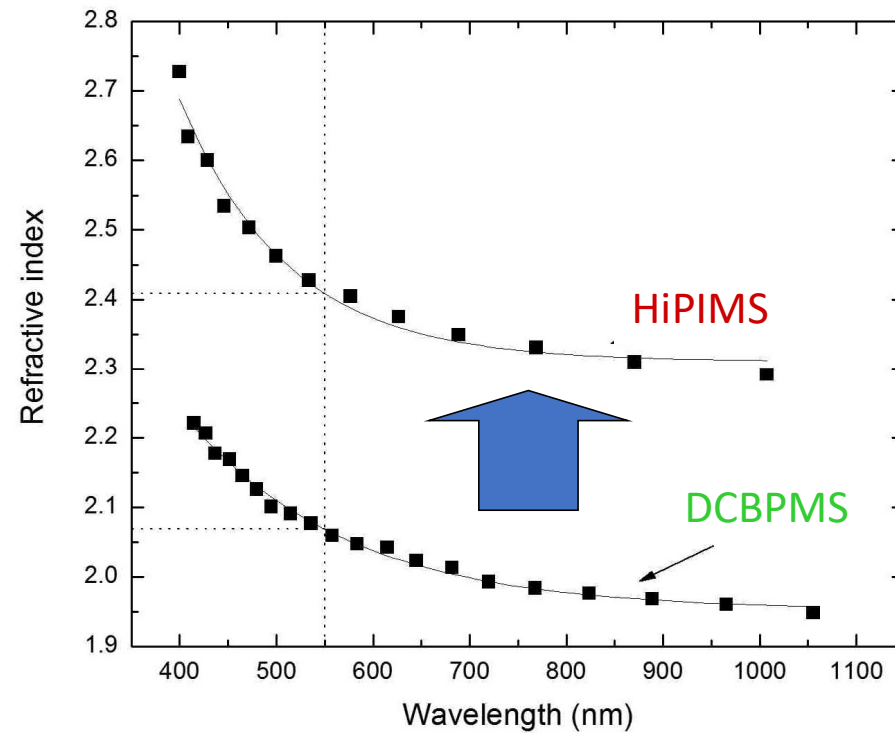
Steel foil at **FLOATING** potential → **ANATASE** structure like on glass

Comparing DC-BPMS and HiPIMS sputtering



- On glass :
ANATASE, different textures
- On steel :
HiPIMS : RUTILE
DCBPMS : ANATASE

Refractive index, TiO₂ on glass



On glass, both films are anatase.

→ Higher index could be attributed to film **densification by HiPIMS**

Influence of substrate, summary

TiO₂ films deposited by HiPIMS

- are denser
- have a different crystalline structure (RUTILE on steel)
- have a higher refractive index

Ionization degree induced by short pulse is enough to modify film properties

Capacitance of substrate is an influential factor regarding the energy deposition during film growth

Energy flux measurements during TiO_2 deposition

Various contributions to the energy flux at the substrate

$$P_E = \int J_{in} \cdot dS = \int (J_i + J_e + J_n + J_{rad} + J_{film}) \cdot dS$$

Diagram illustrating the equation for energy flux at the substrate, with arrows pointing from labels to terms in the equation:

- Total input power (points to P_E)
- Energy delivered per unit time and area (points to J_{in})
- ions (points to J_i)
- electrons (points to J_e)
- neutrals (points to J_n)
- radiations (points to J_{rad})
- condensation of film forming species, chemical reactions, ... (points to J_{film})
- surface (points to dS)

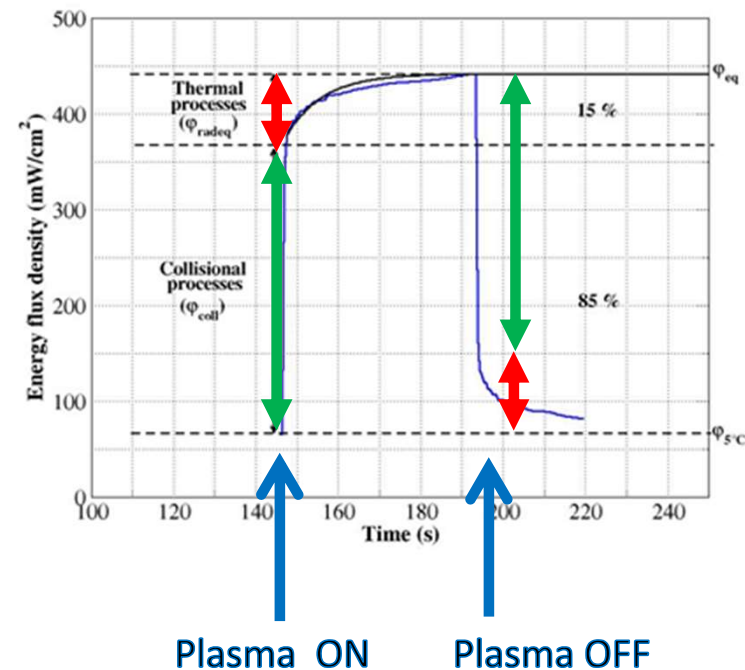
The energy flux at the substrate

Thermopile – based probe

→ Allows to distinguish:

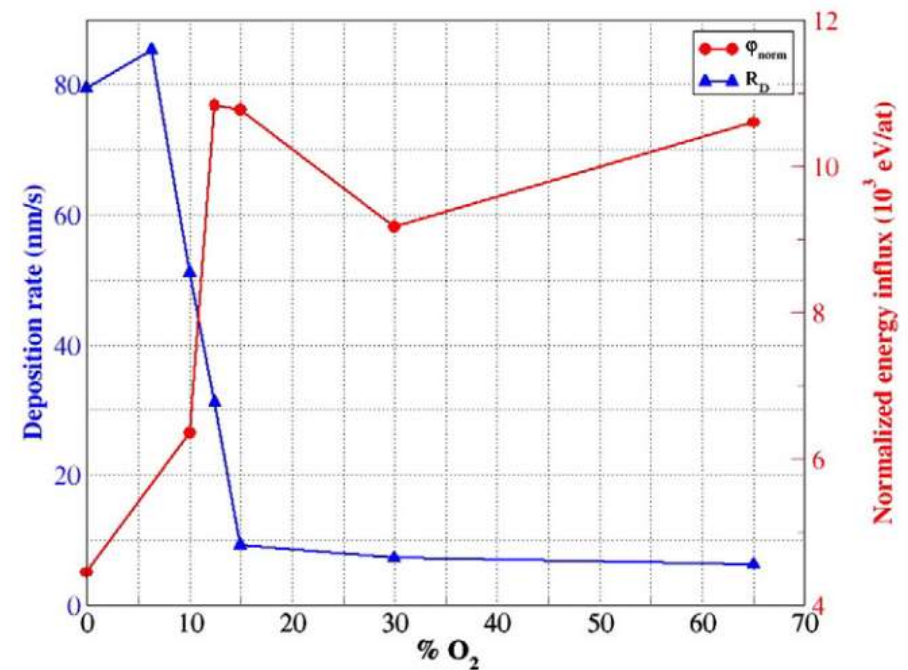
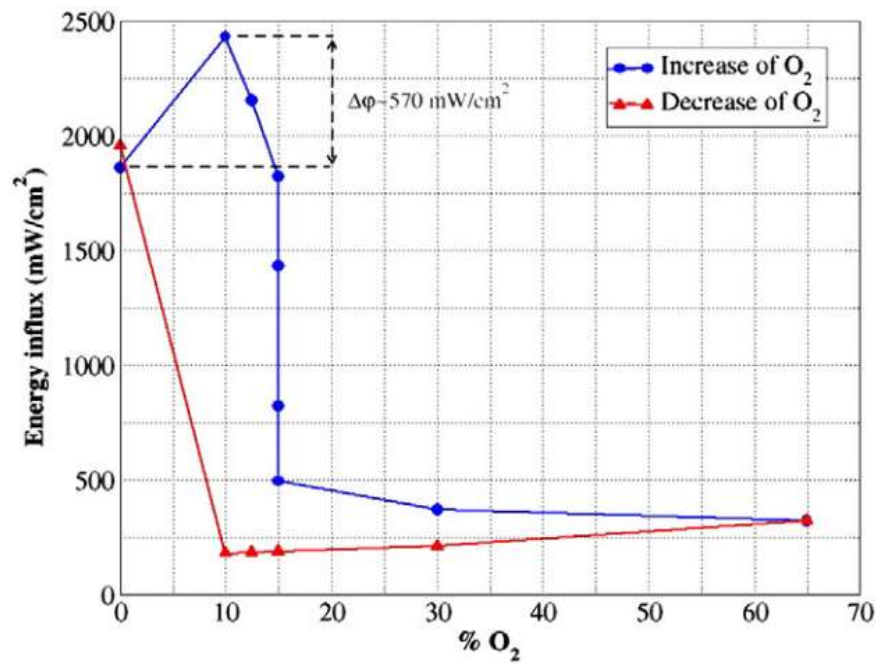
1. **Rapid processes**
 - Plasma related contributions
2. **Slow processes**
 - IR emitted by slowly heated body
→ **Target** bombarded by plasma ions.

Energy Flux vs time



1. P.-A. Cormier et al, J. Appl. Phys. 113, 013305 (2013).
2. P.-A. Cormier et al, Thin Solid Films 545, 44 (2013).
3. A. Thomann, Surf. Coat. Technol. 377, 124887 (2019).

Energy flux at the substrate surface, metallic vs oxide modes

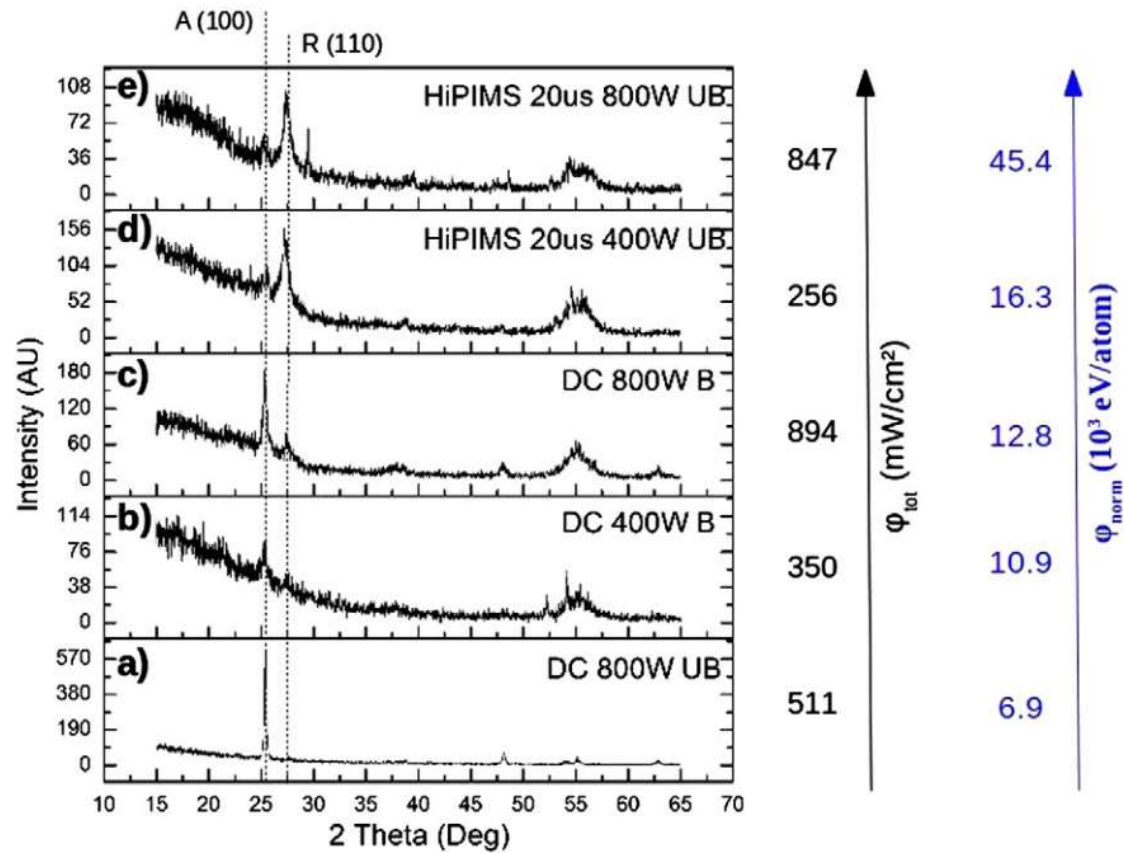


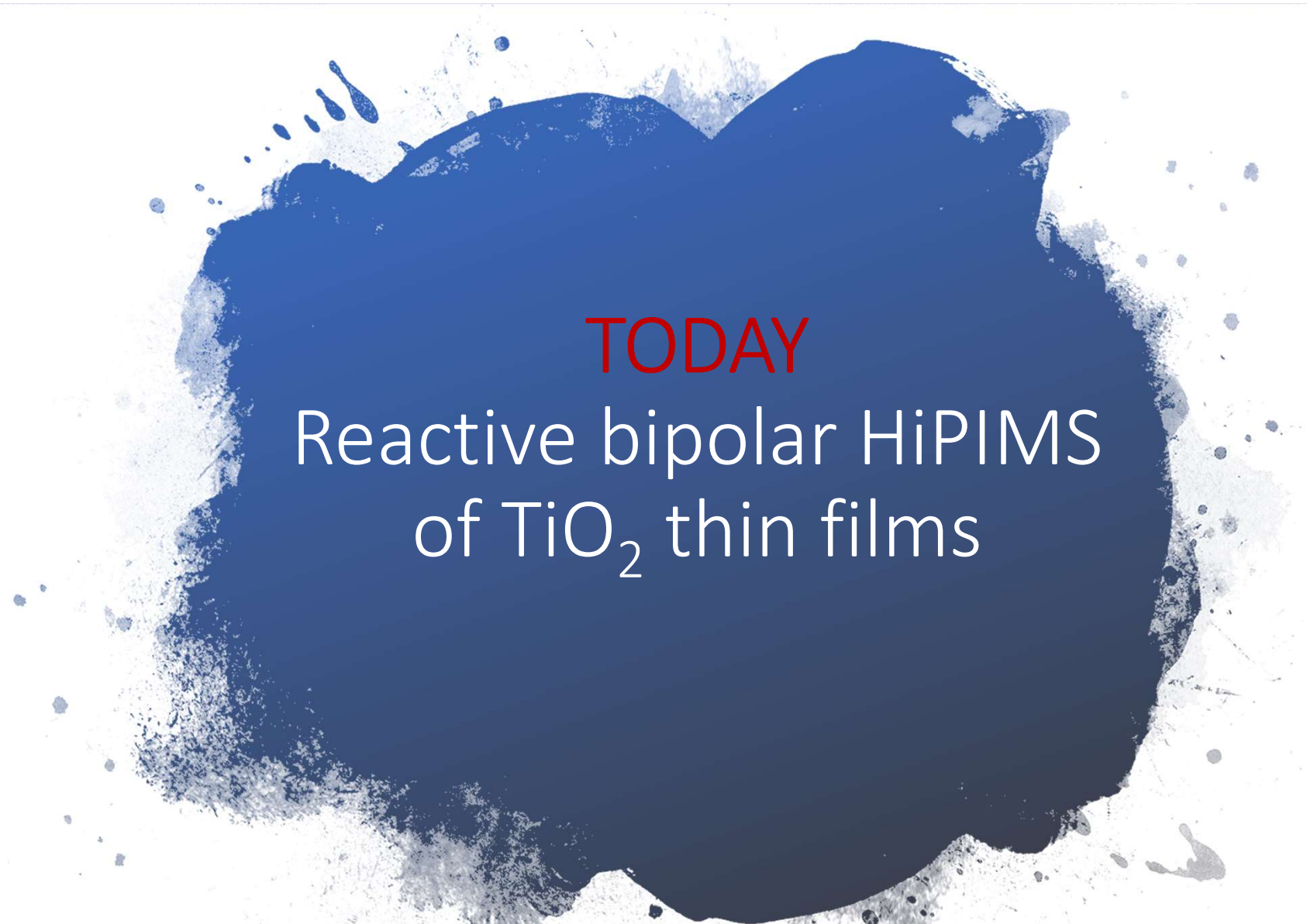
- Increased energy deposition comes from high energy O⁻ negative ions

IR emission from a heated sputter target

Discharge type	Power (W)	Magnetic geometry	Energy flux (mW/cm ²)			NEF (keV/Ti at)	% of IR
			Plasma	IR	Total flux		
HIPIMS	800	UB	682	165	847	45.4	19
HIPIMS	400	UB	223	33	256	16.3	13
DC	800	B	346	548	894	12.8	61
DC	400	B	223	127	350	10.9	36
DC	800	UB	423	88	511	6.9	17

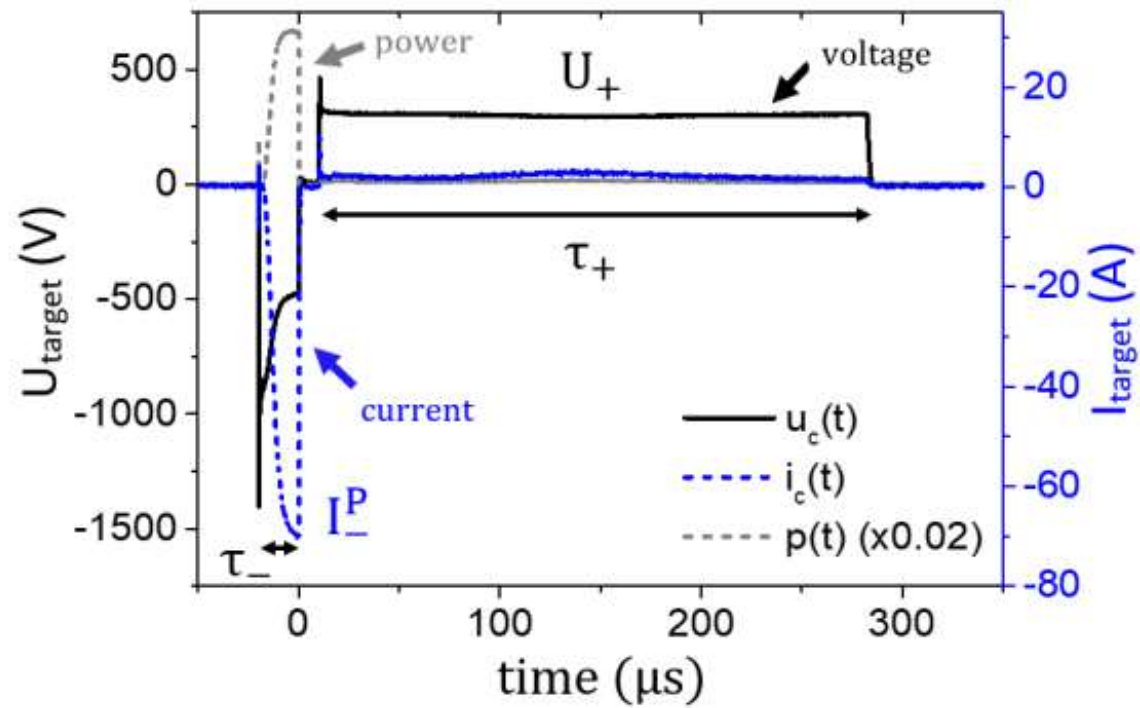
XRD vs Energy per adparticle



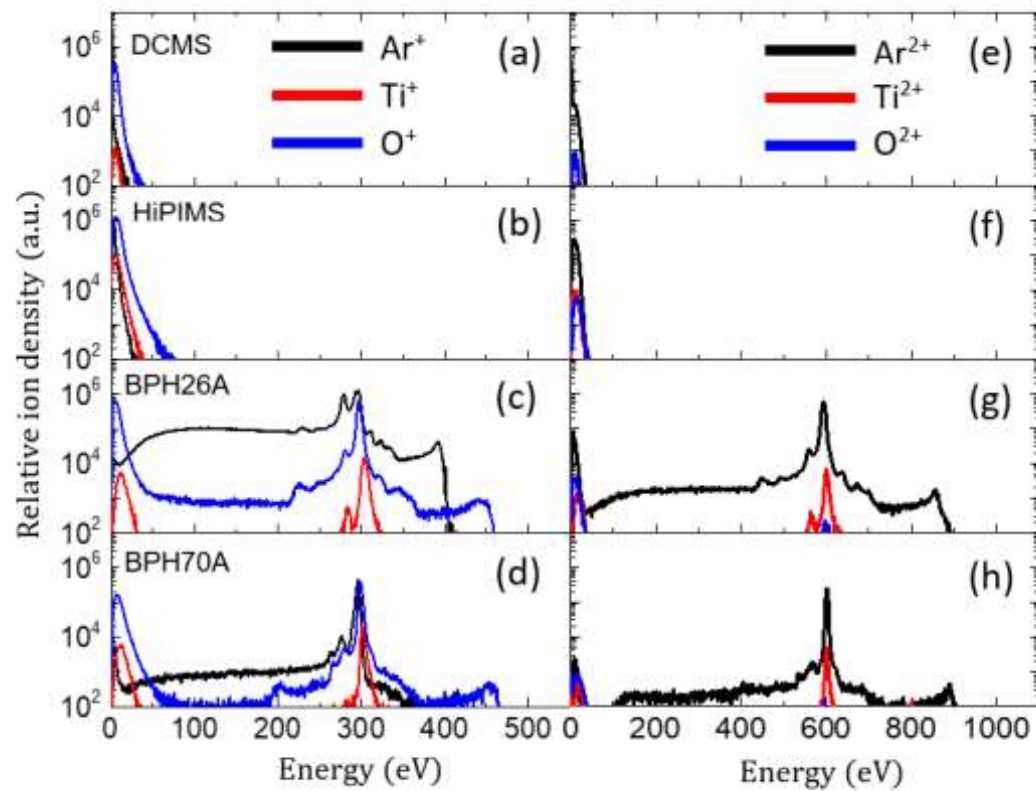


TODAY
Reactive bipolar HiPIMS
of TiO₂ thin films

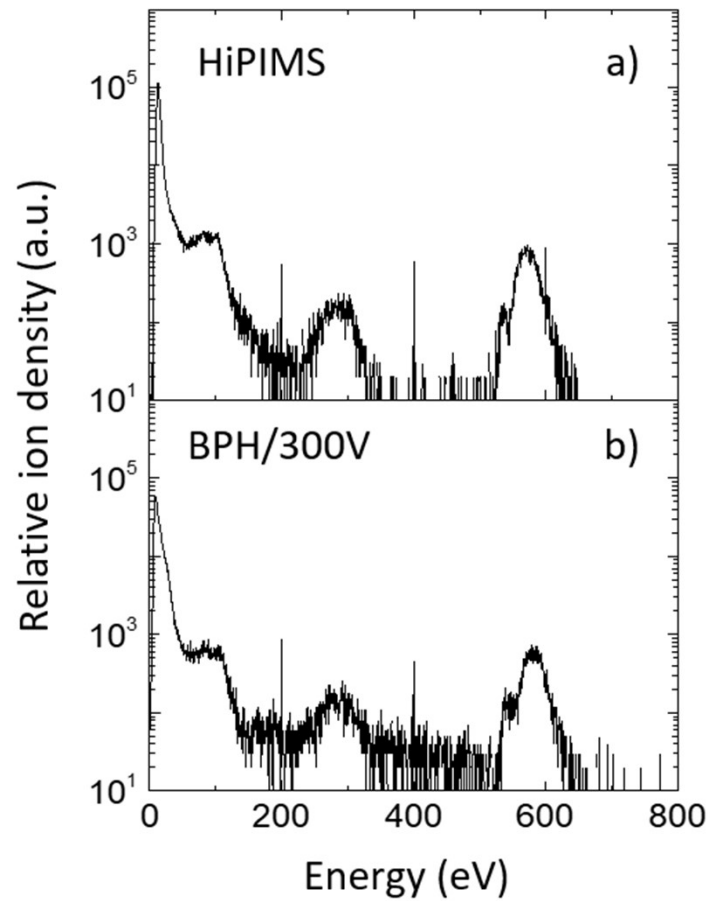
I & V waveforms



Ion Energy Distribution Functions, $U_+ = 300V$

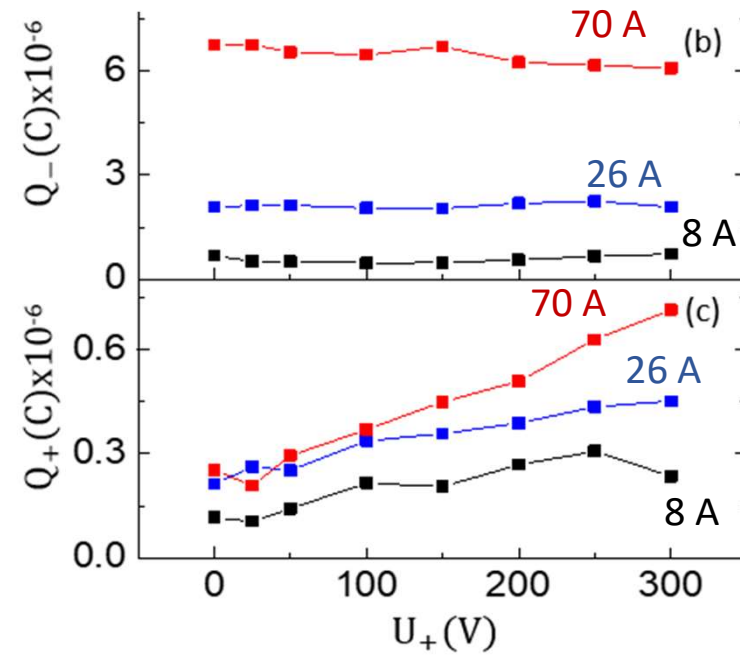


IEDFs for O^- ions, HiPIMS vs B-HiPIMS

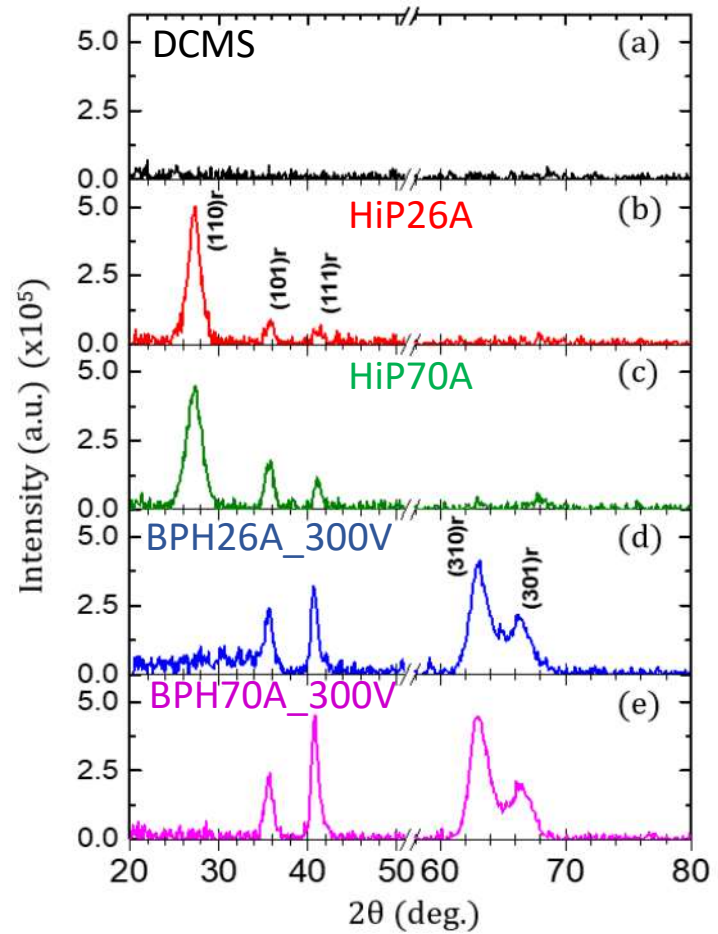


Cathode voltage = 600V

Charge collection at the substrate

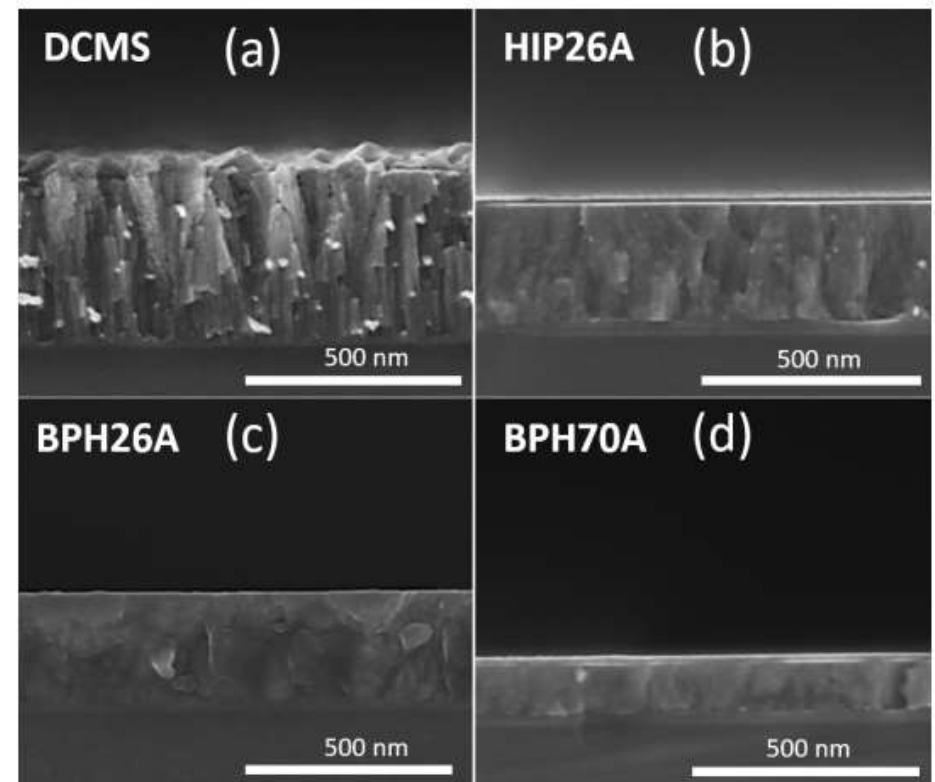
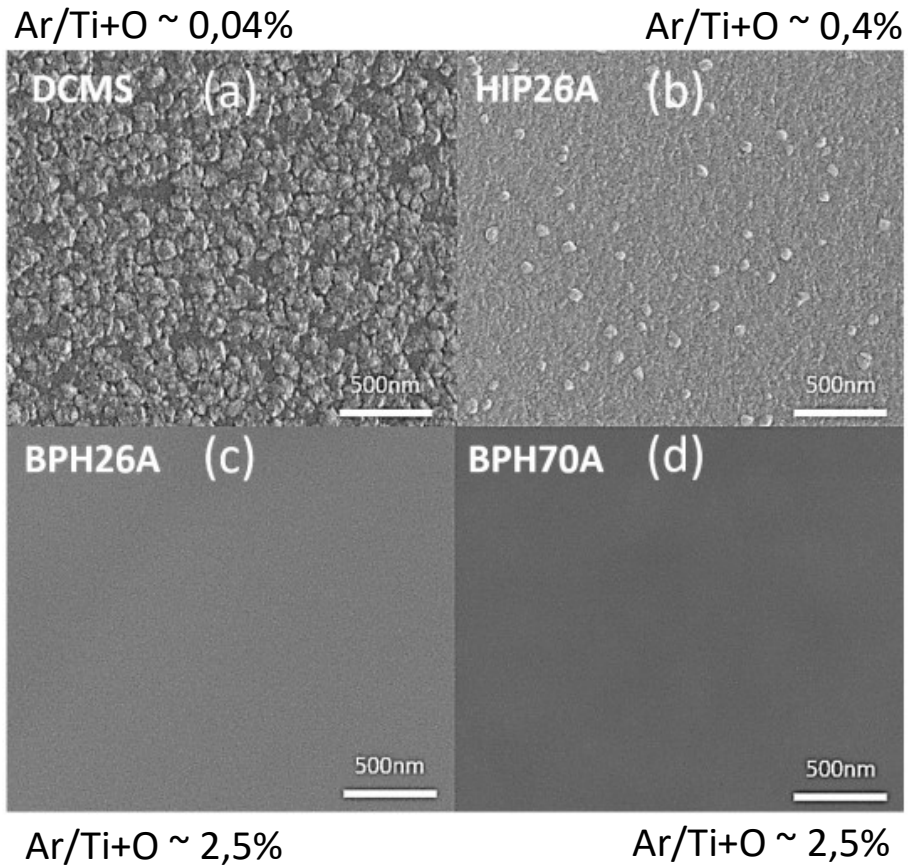


Comparison of the XRD data



Low resistivity Si substrates

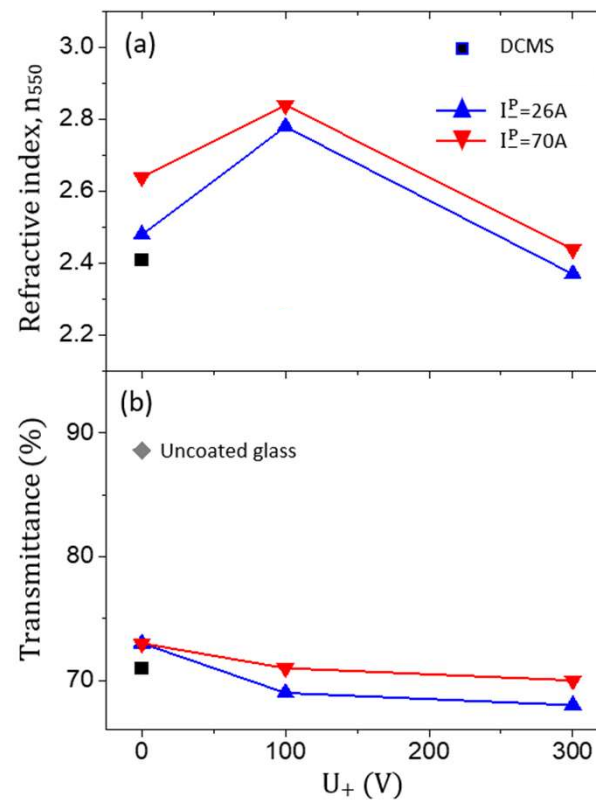
Topography and cross-section SEM images



Refractive index

Process	Density (g/cm ³)	Crystallinity	n (Ellipsometry)
DCMS	3,6	Amorphous	2,41
HiPIMS_26Amp	3,9	rutile	2,53
BPH_26_300V	3,4	rutile	2,49
BPH_70_300V	3,5	rutile	2,60

Bipolar HiPIMS of TiO₂ on glass



Summary

1. Energy deposition is increased when running a HiPIMS plasma
 - Pay attention to the substrate electric connection (floating vs grounded) especially for classic HiPIMS
 - Optimization of the magnetic field is necessary to allow ions to do their job otherwise (balanced field) the target surface may become a radiator and the film is annealed in situ.
2. HiPIMS films are usually found to be well crystallized while DCMS films are amorphous or contain anatase nanocrystals
3. Refractive index is higher in HiPIMS based deposition processes
4. During Bipolar HiPIMS, the positive pulse controls the energy and the amounts of positive ions collected at the substrate
 - Argon is incorporated in the film
5. HiPIMS was tested successfully on a (small scale) rotating magnetron

W.P. Leroy et al, J. Phys. D. Appl. Phys. **44**, 115201 (2011).

What about HiPIMS tomorrow ?

Acknowledgements

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